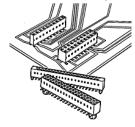
89898-310LF - DUBOX™ : 20 **Position Vertical Card Connector, Surface Mount, Double row, Dual entry**









▶77313-101-20LF №95278-101-20LF

Specifications

Thickness (Board) 1.6 mm (0.062 in.) or 2.36 mm (0.093 in.) 2.54 mm x 7.2 mm (0.1 in. x 0.283 in.) Electrical Current rating 3A max. per Contact/2A max. per Contact for Full Load Resistance (Contact) 15 milli ohms Initial, 20 milli ohms After test Resistance (Insulation) 100000 M-ohms Voltage rating 1000V rms Mechanical Insertion force 1.50N (150 gf) per Contact Withdrawal Force 0.3N (30 gf) min. per Contact	General	
Number of contacts (Total) 20 Number of rows 2 Orientation Vertical Packaging Tube Mating half Mates with 0.64 mm (0.025 in.) Square pins. Series Number 89898 Dimensional	Hold Down Style	No Locating Pegs
Number of rows 2 Orientation Vertical Packaging Tube Mating half Mates with 0.64 mm (0.025 in.) Square pins. Series Number 89898 Dimensional Thickness (Board) Footprint (Board) 2.54 mm x 7.2 mm (0.1 in. x 0.283 in.) Electrical Thickness (Contact) Current rating 3A max. per Contact/2A max. per Contact for Full Load Resistance (Contact) 15 milli ohms Initial, 20 milli ohms After test Resistance (Insulation) 100000 M-ohms Voltage rating 10000 V rms Mechanical 1.50N (150 gf) per Contact Uithdrawal Force 0.3N (30 gf) min. per Contact Withdrawal Force 0.3N (30 gf) min. per Contact Wounting Compatible with Wave, Vapor - Phase Physical Color (Housing) Grey Material (Contact) Phosphor Bronze Material (Housing) High Temperature Thermoplastic Plating (Contact area) 0.76 μm (30 μin.) Gold Plating (Tail) 2.54 μm (100 μin.) Tin Underplating (Contact) 1.27 μ	Number of contacts (per row)	10
Orientation Vertical Packaging Tube Mating half Mates with 0.64 mm (0.025 in.) Square pins. Series Number 89898 Dimensional Thickness (Board) Thickness (Board) 1.6 mm (0.062 in.) or 2.36 mm (0.093 in.) Electrical 2.54 mm x 7.2 mm (0.1 in. x 0.283 in.) Electrical 3A max. per Contact/2A max. per Contact for Full Load Resistance (Contact) 15 milli ohms Initial, 20 milli ohms After test Resistance (Insulation) 100000 M-ohms Voltage rating 10000 V rms Mechanical 40000 V rms Insertion force 1.50N (150 gf) per Contact Withdrawal Force 0.3N (30 gf) min. per Contact Wounting Compatible with Wave, Vapor - Phase Physical Conpatible with Wave, Vapor - Phase Physical Grey Material (Contact) Phosphor Bronze Material (Housing) High Temperature Thermoplastic Plating (Contact area) 0.76 µm (30 µin.) Gold Plating (Tail) 2.54 µm (100 µin.) Tin Underplating (Contact) 1.27 µm (50 µin.) Nickel	Number of contacts (Total)	20
Packaging Tube	Number of rows	2
Mating half Mates with 0.64 mm (0.025 in.) Square pins. Series Number 89898 Dimensional 1.6 mm (0.062 in.) or 2.36 mm (0.093 in.) Footprint (Board) 2.54 mm x 7.2 mm (0.1 in. x 0.283 in.) Electrical Current rating Resistance (Contact) 15 milli ohms Initial, 20 milli ohms After test Resistance (Insulation) 100000 M-ohms Voltage rating 1000V rms Mechanical Insertion force 1.50N (150 gf) per Contact Withdrawal Force 0.3N (30 gf) min. per Contact Wounting Solder process Compatible with Wave, Vapor - Phase Physical Color (Housing) Grey Material (Contact) Phosphor Bronze Material (Housing) High Temperature Thermoplastic Plating (Contact area) 0.76 µm (30 µin.) Gold Plating (Tail) 2.54 µm (100 µin.) Tin Underplating (Contact) 1.27 µm (50 µin.) Nickel	Orientation	Vertical
Series Number 89898 Dimensional 1.6 mm (0.062 in.) or 2.36 mm (0.093 in.) Footprint (Board) 2.54 mm x 7.2 mm (0.1 in. x 0.283 in.) Electrical 3A max. per Contact/2A max. per Contact for Full Load Resistance (Contact) 15 milli ohms Initial, 20 milli ohms After test Resistance (Insulation) 100000 M-ohms Voltage rating 1000V rms Mechanical Insertion force 1.50N (150 gf) per Contact Insertion force 0.3N (30 gf) min. per Contact Withdrawal Force 0.3N (30 gf) min. per Contact Mounting Compatible with Wave, Vapor - Phase Physical Confect (Housing) Grey Material (Contact) Material (Housing) High Temperature Thermoplastic Plating (Contact area) 0.76 μm (30 μin.) Gold Plating (Tail) 2.54 μm (100 μin.) Tin Underplating (Contact) 1.27 μm (50 μin.) Nickel	Packaging	Tube
Dimensional	Mating half	Mates with 0.64 mm (0.025 in.) Square pins.
Thickness (Board)		89898
Footprint (Board) 2.54 mm x 7.2 mm (0.1 in. x 0.283 in.)	Dimensional	
Electrical Current rating 3A max. per Contact/2A max. per Contact for Full Load Resistance (Contact) 15 milli ohms Initial, 20 milli ohms After test Resistance (Insulation) 10000 M-ohms Voltage rating 1000V rms Mechanical Insertion force 1.50N (150 gf) per Contact Withdrawal Force 0.3N (30 gf) min. per Contact Mounting Solder process Compatible with Wave, Vapor - Phase Physical Color (Housing) Grey Material (Contact) Phosphor Bronze Material (Housing) High Temperature Thermoplastic Plating (Contact area) Plating (Contact) 0.76 µm (30 µin.) Gold Plating (Tail) 2.54 µm (100 µin.) Tin Underplating (Contact) 1.27 µm (50 µin.) Nickel	Thickness (Board)	1.6 mm (0.062 in.) or 2.36 mm (0.093 in.)
Current rating3A max. per Contact/2A max. per Contact for Full LoadResistance (Contact)15 milli ohms Initial, 20 milli ohms After testResistance (Insulation)100000 M-ohmsVoltage rating1000V rmsMechanical Insertion force1.50N (150 gf) per ContactWithdrawal Force0.3N (30 gf) min. per ContactWountingCompatible with Wave, Vapor - PhasePhysical Color (Housing)GreyMaterial (Contact)Phosphor BronzeMaterial (Housing)High Temperature ThermoplasticPlating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel		2.54 mm x 7.2 mm (0.1 in. x 0.283 in.)
Resistance (Contact) Resistance (Insulation) 100000 M-ohms 10000 M-ohms 10000 rms Mechanical Insertion force 1.50N (150 gf) per Contact Withdrawal Force 0.3N (30 gf) min. per Contact Mounting Solder process Compatible with Wave, Vapor - Phase Physical Color (Housing) Material (Contact) Material (Contact) Material (Housing) High Temperature Thermoplastic Plating (Contact area) Plating (Contact) Plating (Tail) 1.27 µm (50 µin.) Nickel		
Resistance (Insulation) Voltage rating 10000 M-ohms 10000 rms Mechanical Insertion force 1.50N (150 gf) per Contact Withdrawal Force 0.3N (30 gf) min. per Contact Mounting Solder process Compatible with Wave, Vapor - Phase Physical Color (Housing) Grey Material (Contact) Material (Housing) High Temperature Thermoplastic Plating (Contact area) Plating (Contact) Plating (Tail) 2.54 µm (100 µin.) Tin Underplating (Contact) 1.27 µm (50 µin.) Nickel	•	3A max. per Contact/2A max. per Contact for Full Load
Voltage rating Mechanical Insertion force 1.50N (150 gf) per Contact Withdrawal Force 0.3N (30 gf) min. per Contact Wounting Solder process Compatible with Wave, Vapor - Phase Physical Color (Housing) Grey Material (Contact) Material (Housing) High Temperature Thermoplastic Plating (Contact area) Plating (Tail) 2.54 µm (100 µin.) Tin Underplating (Contact) 1.27 µm (50 µin.) Nickel	Resistance (Contact)	15 milli ohms Initial, 20 milli ohms After test
Mechanical Insertion force 1.50N (150 gf) per Contact Withdrawal Force 0.3N (30 gf) min. per Contact Mounting Solder process Compatible with Wave, Vapor - Phase Physical Color (Housing) Grey Material (Contact) Phosphor Bronze Material (Housing) High Temperature Thermoplastic Plating (Contact area) 0.76 μm (30 μin.) Gold Plating (Tail) 2.54 μm (100 μin.) Tin Underplating (Contact) 1.27 μm (50 μin.) Nickel	Resistance (Insulation)	100000 M-ohms
Insertion force Inser		1000V rms
Withdrawal Force0.3N (30 gf) min. per ContactMounting Solder processCompatible with Wave, Vapor - PhasePhysical Color (Housing)GreyMaterial (Contact)Phosphor BronzeMaterial (Housing)High Temperature ThermoplasticPlating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel	Mechanical	
MountingCompatible with Wave, Vapor - PhasePhysical Color (Housing)GreyMaterial (Contact)Phosphor BronzeMaterial (Housing)High Temperature ThermoplasticPlating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel	Insertion force	1.50N (150 gf) per Contact
Solder processCompatible with Wave, Vapor - PhasePhysical Color (Housing)GreyMaterial (Contact)Phosphor BronzeMaterial (Housing)High Temperature ThermoplasticPlating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel	Withdrawal Force	0.3N (30 gf) min. per Contact
Physical Color (Housing)GreyMaterial (Contact)Phosphor BronzeMaterial (Housing)High Temperature ThermoplasticPlating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel	Mounting	
Color (Housing)GreyMaterial (Contact)Phosphor BronzeMaterial (Housing)High Temperature ThermoplasticPlating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel		Compatible with Wave, Vapor - Phase
Material (Contact)Phosphor BronzeMaterial (Housing)High Temperature ThermoplasticPlating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel	-	Grov
Material (Housing)High Temperature ThermoplasticPlating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel	, ,	
Plating (Contact area) 0.76 μm (30 μin.) Gold Plating (Tail) 2.54 μm (100 μin.) Tin Underplating (Contact) 1.27 μm (50 μin.) Nickel		·
Plating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel		
Underplating (Contact) 1.27 μm (50 μin.) Nickel		
	Plating (Tail)	2.54 µm (100 µin.) Tin
Flammability rating UL 94 V-0	Underplating (Contact)	1.27 μm (50 μin.) Nickel
	Flammability rating	UL 94 V-0

Temperature (Range)	-65 °C to +125 °C
Approvals / Certifications UL File Number	E66906
Approvals / Certifications	UL and CSA Approved

